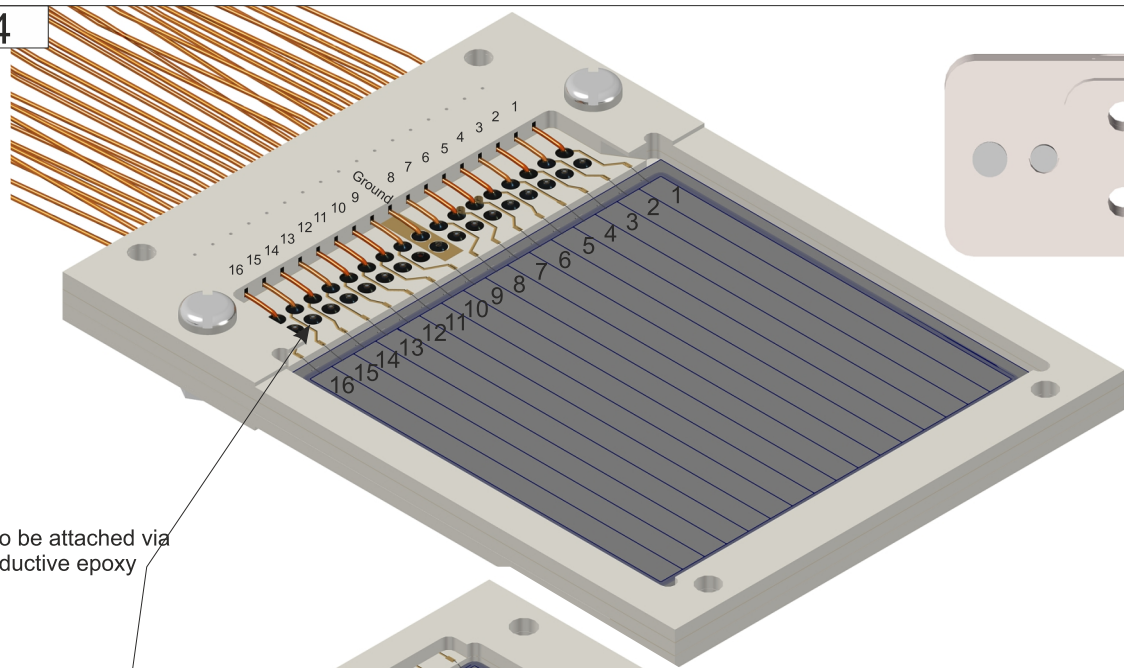
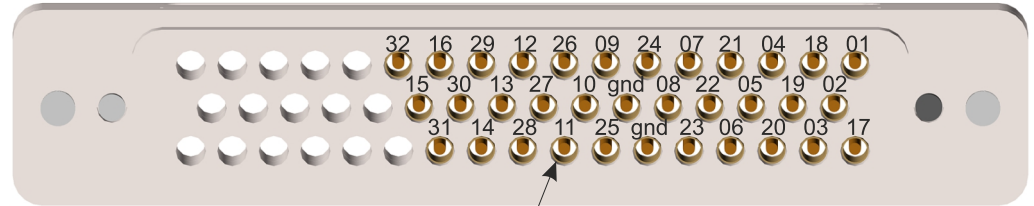


Front View



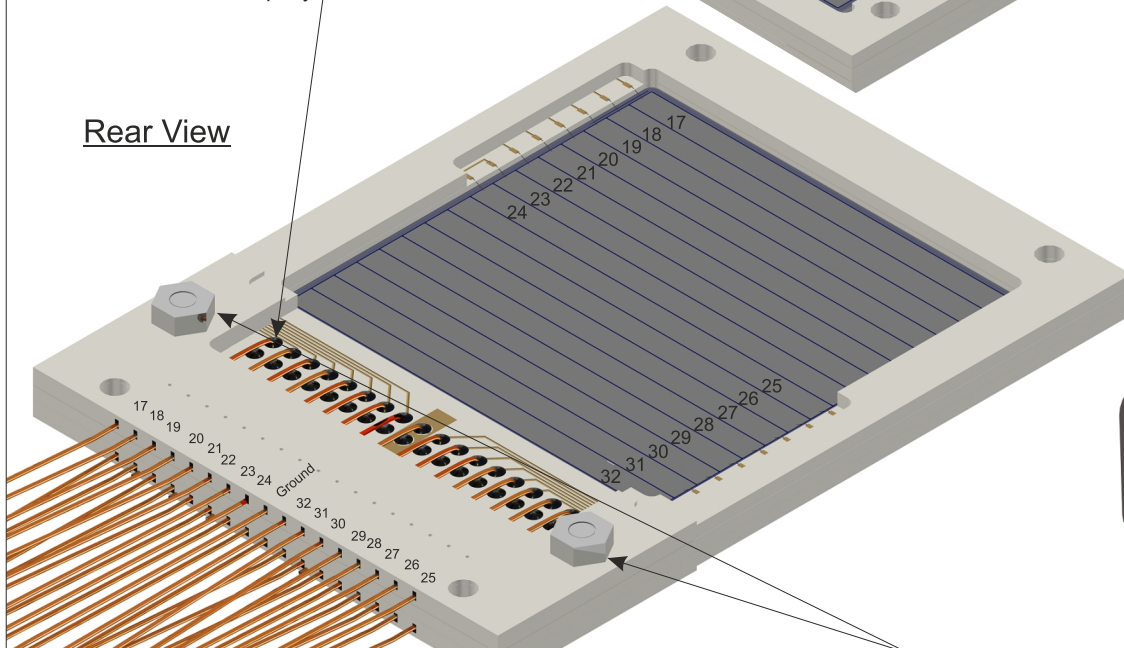
Ceramic Connector Outputs



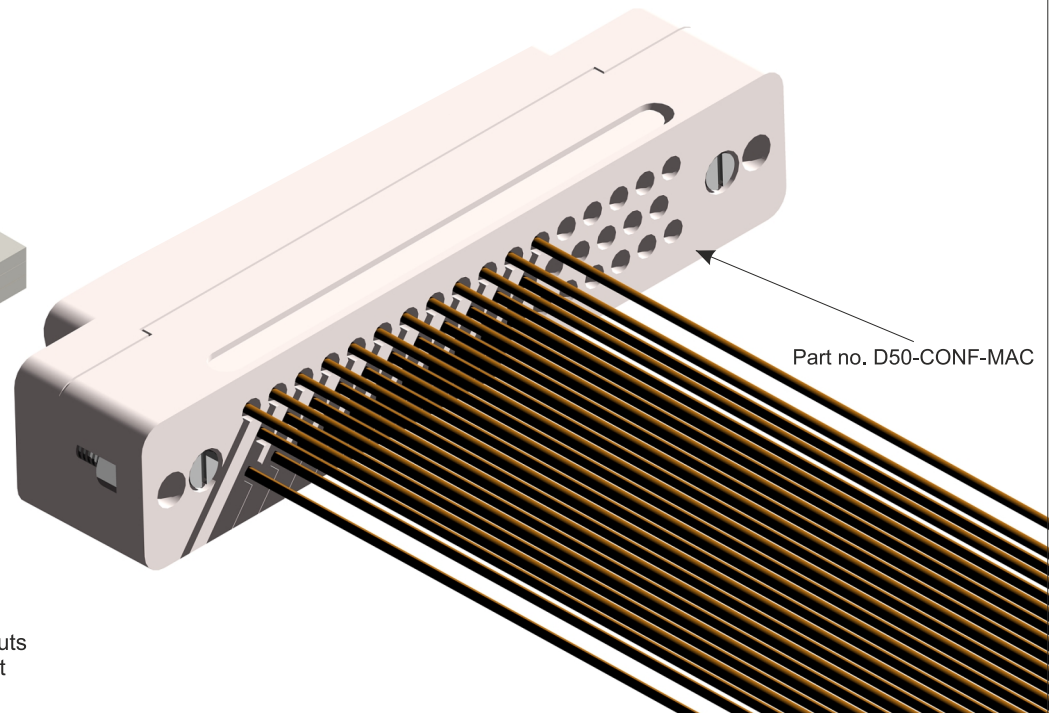
Connector outputs to be crimped using crimps part no. DPINF-25 and crimp tool Part no. DCT1

Wires to be attached via conductive epoxy

Rear View



Ceramic Connector



PCB Dimensions = 63.50 x 86.50 x 4.90 mm<sup>3</sup>  
 Chip Dimensions = 53.78 x 53.78 mm<sup>2</sup>  
 Active Area = 49.50 x 49.50 mm<sup>2</sup>

2 x Stainless steel screws and nuts  
 no thread showing past the nut

Drawn N.W Des. Appd	Checked S.W	Date 28/09/2017	<b>Tolerances Unless Stated</b>	Outputs Via: 210 cm long Kapton Wire, LewVac Pt no. KAPW7X008 into Part no. D50-CONF-MAC	Title.  Design W type 2M/2M. On 2017 Design Rogers PCB 3D Assembly.
			x.xx = ± 0.1 mm	Mating connector:	
			x.xxx = ± 0.01 mm	Testing Mating connector: N/A	
			Angular ± 0.25°	Substrate Number: A-4723 and A-4724      Potted Wire Bonds: No	
			Material Thickness ± 10%	Substrate Material: Rogers 4350	
				Connector Orientation: Straight connector at end of cables.	



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Scale N/A

Dims In. mm

Drg No C-2994